## 506026108 04/22/2020

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6072823

SUBMISSION TYPE:		NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT	
CONVEYING PARTY DA	ATA			
		Name	Execution Date	
SHUAI ZHANG			12/24/2014	
LIAN-JIE LI			12/24/2014	
ZHONG-HAO CHEN			12/24/2014	
FENG HAN			12/24/2014	
JIAN WU			12/24/2014	
RECEIVING PARTY DA	 ТА			
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.			
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK			
City:	HSINCHU			
State/Country:	TAIWAN			
Postal Code:	300			
Property Type		Number	_	
Application Number:		16855253		
· · · · · · · · · · · · · · · · · · ·				
CORRESPONDENCE D	ΑΤΑ	(703)518-5499		
CORRESPONDENCE DA Fax Number: Correspondence will be	e sent to	(703)518-5499 o the e-mail address first; if that is u		
CORRESPONDENCE D Fax Number: <i>Correspondence will be</i> <i>using a fax number, if p</i>	e sent to	(703)518-5499		
CORRESPONDENCE DA Fax Number: <i>Correspondence will be</i>	e sent to	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be s		
CORRESPONDENCE D Fax Number: <i>Correspondence will be</i> <i>using a fax number, if p</i> Phone: Email:	e sent to	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be s 7036841111		
CORRESPONDENCE DA Fax Number: <i>Correspondence will be</i> <i>using a fax number, if p</i> Phone:	e sent to	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be s 7036841111 tsmc@ipfirm.com		
CORRESPONDENCE DA Fax Number: <i>Correspondence will be</i> <i>using a fax number, if p</i> Phone: Email: Correspondent Name: Address Line 1:	e sent to	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC)		
CORRESPONDENCE DA Fax Number: <i>Correspondence will be using a fax number, if p</i> Phone: Email: Correspondent Name:	e sent to	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD		
CORRESPONDENCE DA Fax Number: <i>Correspondence will be using a fax number, if p</i> Phone: Email: Correspondent Name: Address Line 1: Address Line 2:	e sent to provideo	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD SUITE 1400 ALEXANDRIA, VIRGINIA 22314		
CORRESPONDENCE DA Fax Number: Correspondence will be using a fax number, if p Phone: Email: Correspondent Name: Address Line 1: Address Line 2: Address Line 4:	e sent to provideo	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD SUITE 1400 ALEXANDRIA, VIRGINIA 22314		
CORRESPONDENCE DA Fax Number: Correspondence will be using a fax number, if p Phone: Email: Correspondent Name: Address Line 1: Address Line 2: Address Line 4:	e sent to provideo	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD SUITE 1400 ALEXANDRIA, VIRGINIA 22314		
CORRESPONDENCE DA Fax Number: Correspondence will be using a fax number, if p Phone: Email: Correspondent Name: Address Line 1: Address Line 2: Address Line 2: Address Line 4: ATTORNEY DOCKET NU	e sent to provideo	(703)518-5499 o the e-mail address first; if that is u d; if that is unsuccessful, it will be so 7036841111 tsmc@ipfirm.com HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD SUITE 1400 ALEXANDRIA, VIRGINIA 22314 T5057-1388A RANDY A. NORANBROCK		

source=EFiledAssgnCopy#page1.tif source=EFiledAssgnCopy#page2.tif

Inventor(s)-to-Assignce

## ASSIGNMENT

FOR MANUFACTURING THE SAME AND METHOD FOR MANUFACTURING

SUPER JUNCTION STRUCTURE

The PATENT RIGHTS referred to in this agreement are:

(check one) a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

U.S. patent application Serial No.\_\_\_\_, filed \_\_\_\_\_.

a U.S. patent application based on PCT International Application

No.\_\_\_\_\_\_ filed on (date) \_\_\_\_\_\_(U.S. patent application Serial No.\_\_\_\_\_\_, if known).

U.S. patent No.\_\_\_\_, issued \_\_\_\_\_

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) XU.S. patent rights only.

Worldwide patent rights. In this case, the assignee shall have the right to

claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignce) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.

(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,

TAIWAN 300, R.O.C.

The ASSIGNEE is:

(check one) An individual.

A Partnership.

A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country)

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable

provisions, based on any earlier patent applications for this invention.

## PATENT REEL: 052464 FRAME: 0396

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: SEMICONDUCTOR DEVICE HAVING SUPER JUNCTION STRUCTURE, METHOD FOR MANUFACTURING THE SAME AND METHOD FOR MANUFACTURING SUPER JUNCTION STRUCTURE

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Shuai ZHANG

Name of sole or first inventor

Signature

Date

Lian-Jie LI Name of second inventor, if any

Zhong-Hao CHEN Name of third inventor, if any

Feng HAN Name of fourth inventor, if any

Jian WU Name of fifth inventor, if any

Signature

Signature

Signature

Signature

2014/12/24 Date

Date